

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Hiroshi Fukui

Confirmation No.: 7869

Serial No.: 10/533,849

Filed: October 24, 2005

Group Art Unit: 1796

Examiner: Loewe, Robert S.

For: HEAT CONDUCTIVE SILICONE COMPOSITION

**RESPONSE AFTER FINAL REJECTION**

Mailstop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Dear Sir:

In response to the final Office Action dated January 9, 2009, please consider the accompanying remarks. A complete listing of all claims pending in the application is included for the Examiner's convenience. This response is timely filed; thus, it is believed that no fees are presently due. Further, this response is filed within two months from the mailing date of the final Office Action.

OK TO ENTER: /R.L./